



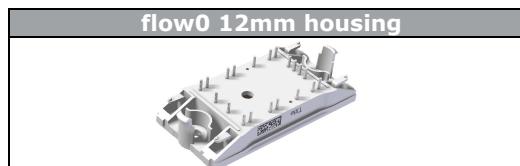
Vincotech

**10-FZ12NMA080SH01-M260F**  
**10-PZ12NMA080SH01-M260FY**

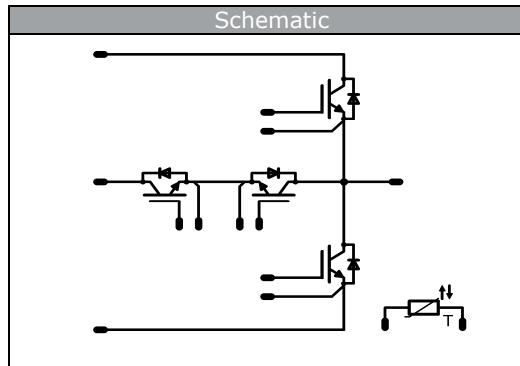
datasheet

**flowMNPC 0****1200 V / 80 A**

Features
<ul style="list-style-type: none"> <li>• mixed voltage component topology</li> <li>• neutral point clamped inverter</li> <li>• reactive power capability</li> <li>• low inductance layout</li> </ul>



Target Applications
<ul style="list-style-type: none"> <li>• solar inverter</li> <li>• UPS</li> </ul>



Types
<ul style="list-style-type: none"> <li>• 10-FZ12NMA080SH01-M260F</li> <li>• 10-PZ12NMA080SH01-M260FY</li> </ul>

**Maximum Ratings** $T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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**Half Bridge IGBT**

Collector-emitter break down voltage	$V_{CE}$		1200	V
DC collector current	$I_C$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	69 88	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	240	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	158 239	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	10 800	$\mu\text{s}$ V
Turn off safe operating area (RBSOA)	$I_{cmax}$	$V_{CE} \text{ max} = 1200\text{V}$ $T_{vj} \text{ max} \leq 150^\circ\text{C}$	160	A
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$

**Neutral Point FWD**

Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	47 62	A
Surge forward current	$I_{FSM}$	$t_p=8,3\text{ms}, \sin 180^\circ$	600	A
I <sup>2</sup> t-value	$I^2t$		1490	A2s
Repetitive peak forward current	$I_{FRM}$	Square wave, 20 kHz	120	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	58 88	W
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$



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datasheet

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Neutral Point IGBT</b>				
Collector-emitter break down voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	52 68	A
Repetitive peak collector current	$I_{CRM}$	$t_p$ limited by $T_{jmax}$	225	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	72 109	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE}=15\text{V}$	6 360	$\mu\text{s}$ V
Turn off safe operating area (RBSOA)	$I_{cmax}$	$V_{CE}$ max = 600V $T_{vj}$ max $\leq 150^\circ\text{C}$	150	A
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Half Bridge FWD

Peak Repetitive Reverse Voltage	$V_{RRM}$		1200	V
DC forward current	$I_F$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	47 62	A
Surge forward current	$I_{FSM}$		335	A
I <sup>2</sup> t-value	$I^2t$	$t_p=10\text{ms}, \sin 180^\circ$ $T_j=125^\circ\text{C}$	560	A2s
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	100	A
Power dissipation	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	79 119	W
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Thermal Properties

Storage temperature	$T_{stg}$		-40...+125	$^\circ\text{C}$
Operation temperature under switching condition	$T_{op}$		-40...+( $T_{jmax} - 25$ )	$^\circ\text{C}$

## Insulation Properties

Insulation voltage	$V_{is}$	$t=2\text{s}$	DC voltage	4000	V
Creepage distance				min 12,7	mm
Clearance				8,95	mm

**Characteristic Values**

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max	

**Half Bridge IGBT**

Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,003	$T_j=25^\circ C$ $T_i=125^\circ C$	5,2	5,8	6,4	V
Collector-emitter saturation voltage	$V_{CESat}$		15		80	$T_j=25^\circ C$ $T_i=125^\circ C$	1,7	1,99 2,33	2,5	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	1200		$T_j=25^\circ C$ $T_i=125^\circ C$			0,02	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ C$ $T_i=125^\circ C$			240	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=4 \Omega$ $R_{gon}=4 \Omega$	$\pm 15$	350	56	$T_j=25^\circ C$ $T_i=125^\circ C$		77 78		ns
Rise time	$t_r$					$T_j=25^\circ C$ $T_i=125^\circ C$		12 16		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ C$ $T_i=125^\circ C$		173 225		
Fall time	$t_f$					$T_j=25^\circ C$ $T_i=125^\circ C$		49 67		
Turn-on energy loss	$E_{on}$					$T_j=25^\circ C$ $T_i=125^\circ C$		0,46 0,96		mWs
Turn-off energy loss	$E_{off}$					$T_j=25^\circ C$ $T_i=125^\circ C$		1,34 2,24		
Input capacitance	$C_{ies}$	$f=1MHz$	0	25		$T_j=25^\circ C$		4660		pF
Output capacitance	$C_{oss}$							300		
Reverse transfer capacitance	$C_{rss}$							260		
Gate charge	$Q_G$		$\pm 15$	960	80	$T_j=25^\circ C$		370		nC
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\mu m$ $\lambda = 1 \text{ W/mK}$						0,60		K/W

**Neutral Point FWD**

Diode forward voltage	$V_F$				60	$T_j=25^\circ C$ $T_i=125^\circ C$		2,27 1,68	2,8	V
Peak reverse recovery current	$I_r$			600		$T_j=25^\circ C$ $T_i=125^\circ C$		64 83		A
Reverse recovery time	$t_{rr}$	$R_{gon}=4 \Omega$	$\pm 15$	350	56	$T_j=25^\circ C$ $T_i=125^\circ C$		29 74		ns
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ C$ $T_i=125^\circ C$		1 3		$\mu C$
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					$T_j=25^\circ C$ $T_i=125^\circ C$		8651 3565		$A/\mu s$
Reverse recovered energy	$E_{rec}$					$T_j=25^\circ C$ $T_i=125^\circ C$		0,18 0,53		mWs
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\mu m$ $\lambda = 1 \text{ W/mK}$						1,63		K/W

**Characteristic Values**

Parameter	Symbol	Conditions					Value			Unit
			$V_{GE}$ [V] or $V_{GS}$ [V]	$V_r$ [V] or $V_{CE}$ [V] or $V_{DS}$ [V]	$I_c$ [A] or $I_F$ [A] or $I_D$ [A]	$T_j$	Min	Typ	Max	
<b>Neutral Point IGBT</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,0012	$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CESat}$		15		75	$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$	1,05	1,45 1,59	1,85	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	600		$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$			15	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$			600	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=4 \Omega$ $R_{gon}=4 \Omega$	$\pm 15$	350	56	$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		84		ns
Rise time	$t_r$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		85		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		11		
Fall time	$t_f$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		12		
Turn-on energy loss	$E_{on}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		177		mWs
Turn-off energy loss	$E_{off}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		205		
Input capacitance	$C_{ies}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		87		
Output capacitance	$C_{oss}$	$f=1\text{MHz}$	$0$	25		$T_j=25^\circ\text{C}$		105		pF
Reverse transfer capacitance	$C_{rss}$					$T_j=25^\circ\text{C}$		0,53		
Gate charge	$Q_G$					$T_j=25^\circ\text{C}$		0,75		
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1 \text{ W/mK}$						1,86		
								2,50		
								1,32		K/W
<b>Half Bridge FWD</b>										
Diode forward voltage	$V_F$				50	$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$	1,35	1,73 1,70	2,1	V
Reverse leakage current	$I_r$			1200		$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$			10	$\mu\text{A}$
Peak reverse recovery current	$I_{RRM}$	$\pm 15$	350	56		$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		106		A
Reverse recovery time	$t_{rr}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		118		ns
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		102		
Peak rate of fall of recovery current	$(di_{rf}/dt)_{max}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		148		
Reverse recovery energy	$E_{rec}$					$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		5,32 8,22		$\mu\text{C}$
						$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		6904 4951		$\text{A}/\mu\text{s}$
Thermal resistance chip to heatsink	$R_{th(j-s)}$	Thermal grease thickness $\leq 50\mu\text{m}$ $\lambda = 1 \text{ W/mK}$				$T_j=25^\circ\text{C}$ $T_i=125^\circ\text{C}$		1,55 2,42		mWs
								1,21		K/W
<b>Rated resistance</b>										
Rated resistance	$R$					$T_j=25^\circ\text{C}$		22000		$\Omega$
Deviation of R100	$\Delta R/R$	$R100=1486\Omega$				$T_j=100^\circ\text{C}$	-12		11	%
Power dissipation	$P$					$T_j=25^\circ\text{C}$		200		mW
Power dissipation constant						$T_j=25^\circ\text{C}$		2		$\text{mW}/\text{K}$
B-value	$B_{(25/50)}$	Tol. ±3%				$T_j=25^\circ\text{C}$		3950		K
B-value	$B_{(25/100)}$	Tol. ±3%				$T_j=25^\circ\text{C}$		3996		K
Vincotech NTC Reference									B	



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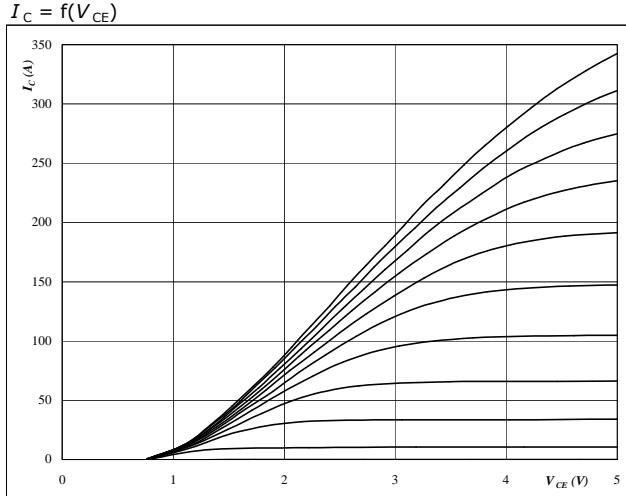
**10-FZ12NMA080SH01-M260F  
10-PZ12NMA080SH01-M260FY**

datasheet

## Half Bridge

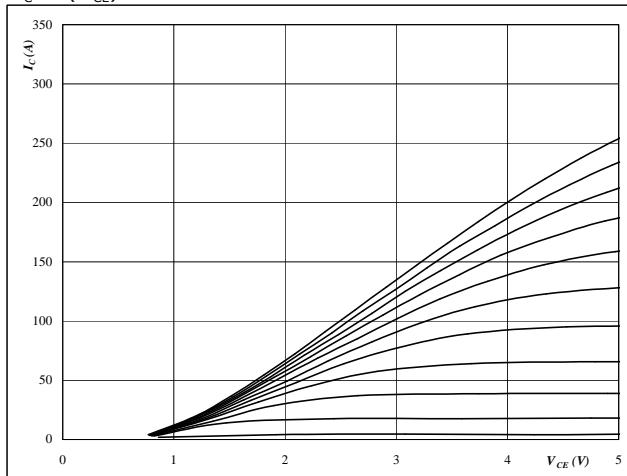
**Half Bridge IGBT and Neutral Point FWD**

**Figure 1**  
**Typical output characteristics**  
 $I_C = f(V_{CE})$



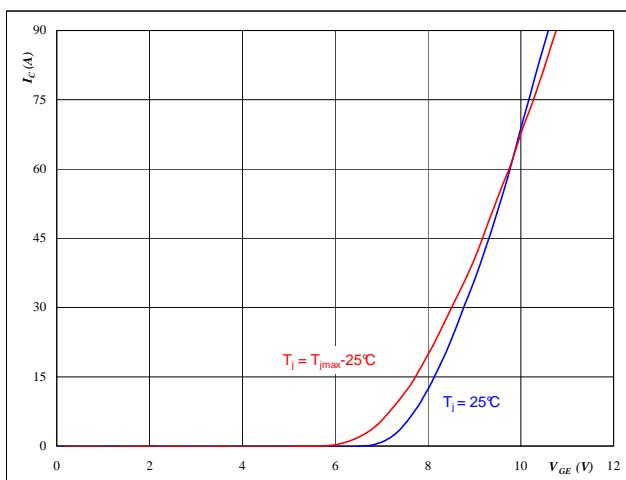
**At**  
 $t_p = 250 \mu s$   
 $T_j = 25^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 2**  
**Typical output characteristics**  
 $I_C = f(V_{CE})$



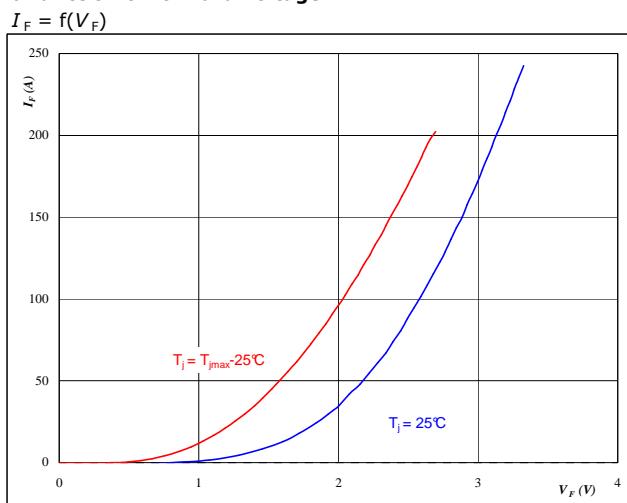
**At**  
 $t_p = 250 \mu s$   
 $T_j = 125^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

**Figure 3**  
**Typical transfer characteristics**  
 $I_C = f(V_{GE})$



**At**  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

**Figure 4**  
**Typical diode forward current as a function of forward voltage**  
 $I_F = f(V_F)$



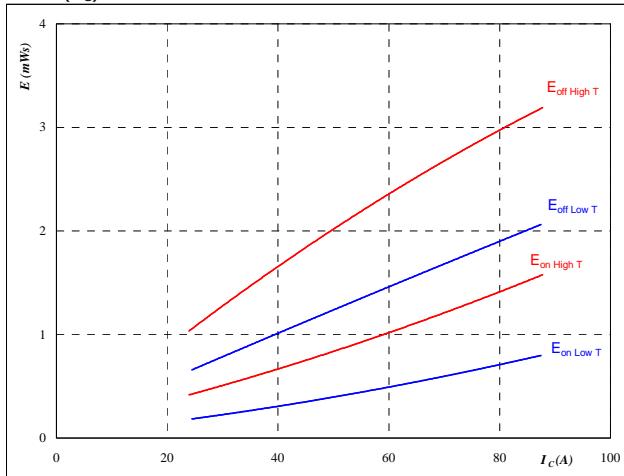
**At**  
 $t_p = 250 \mu s$

## Half Bridge

Half Bridge IGBT and Neutral Point FWD

**Figure 5**  
Typical switching energy losses  
as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

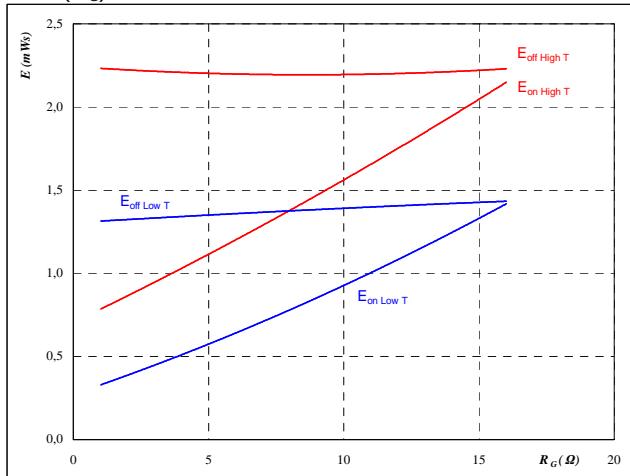
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

$$R_{goff} = 4 \quad \Omega$$

**Figure 6**  
Typical switching energy losses  
as a function of gate resistor

$$E = f(R_G)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

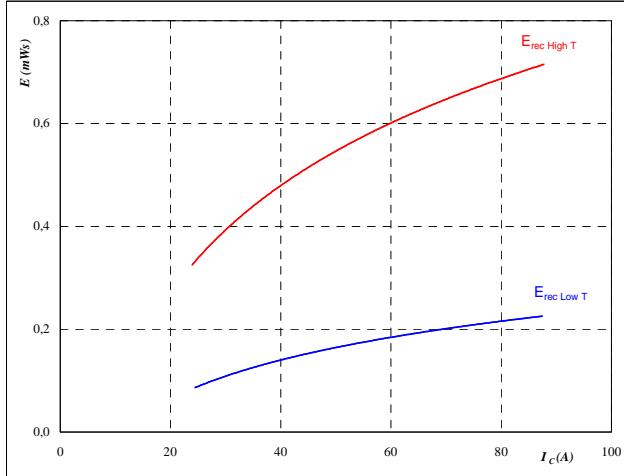
$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 56 \quad \text{A}$$

**Figure 7**  
Typical reverse recovery energy loss  
as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

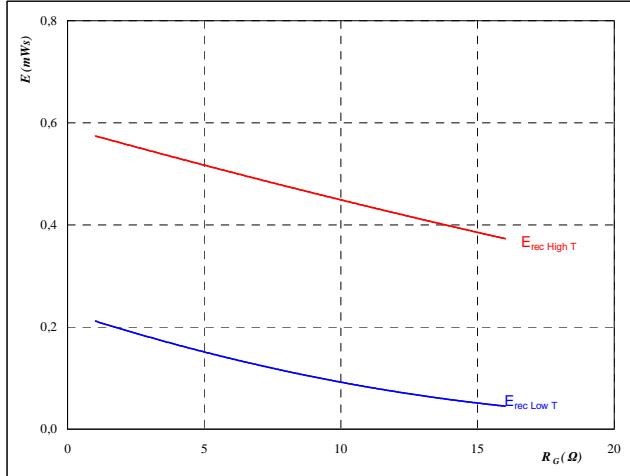
$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**Figure 8**  
Typical reverse recovery energy loss  
as a function of gate resistor

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 56 \quad \text{A}$$



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10-PZ12NMA080SH01-M260FY**

datasheet

## Half Bridge

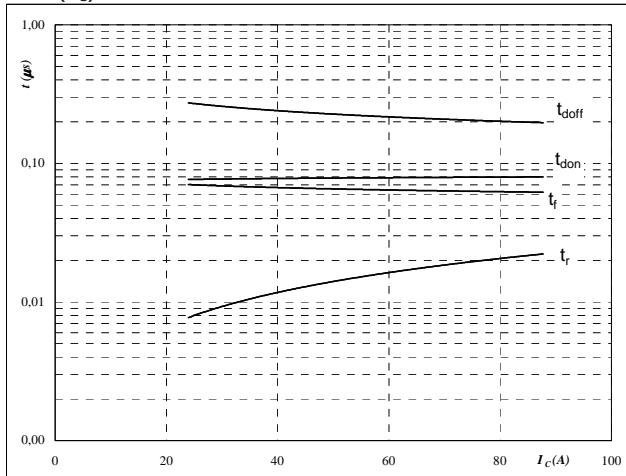
### Half Bridge IGBT and Neutral Point FWD

**Figure 9**

IGBT

**Typical switching times as a function of collector current**

$$t = f(I_c)$$



With an inductive load at

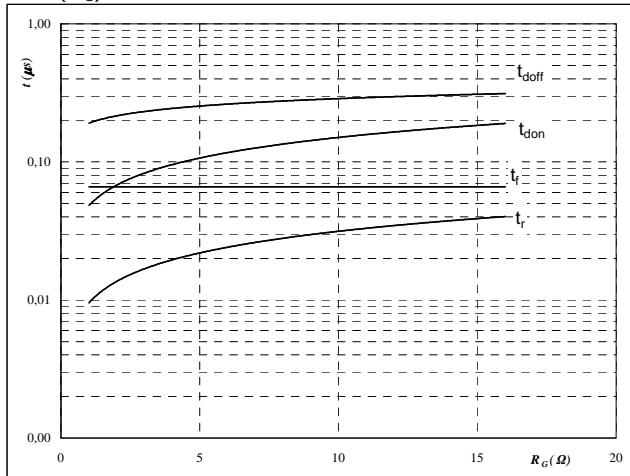
T <sub>j</sub> =	125	°C
V <sub>CE</sub> =	350	V
V <sub>GE</sub> =	±15	V
R <sub>gon</sub> =	4	Ω
R <sub>goff</sub> =	4	Ω

**Figure 10**

IGBT

**Typical switching times as a function of gate resistor**

$$t = f(R_g)$$



With an inductive load at

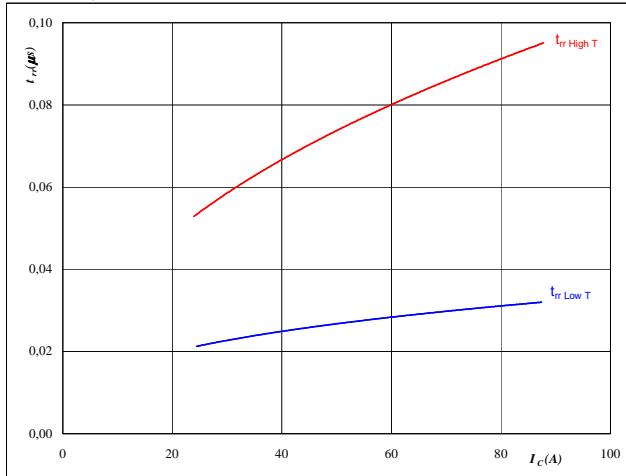
T <sub>j</sub> =	125	°C
V <sub>CE</sub> =	350	V
V <sub>GE</sub> =	±15	V
I <sub>C</sub> =	56	A

**Figure 11**

FWD

**Typical reverse recovery time as a function of collector current**

$$t_{rr} = f(I_c)$$

**At**

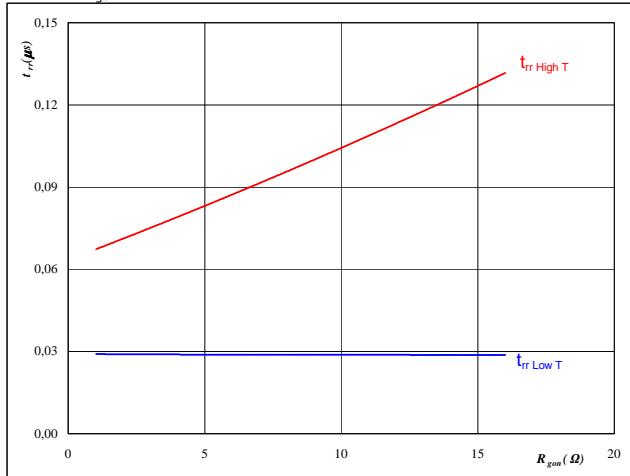
T <sub>j</sub> =	25/125	°C
V <sub>CE</sub> =	350	V
V <sub>GE</sub> =	±15	V
R <sub>gon</sub> =	4	Ω

**Figure 12**

FWD

**Typical reverse recovery time as a function of IGBT turn on gate resistor**

$$t_{rr} = f(R_{gon})$$

**At**

T <sub>j</sub> =	25/125	°C
V <sub>R</sub> =	350	V
I <sub>F</sub> =	56	A
V <sub>GE</sub> =	±15	V

## Half Bridge

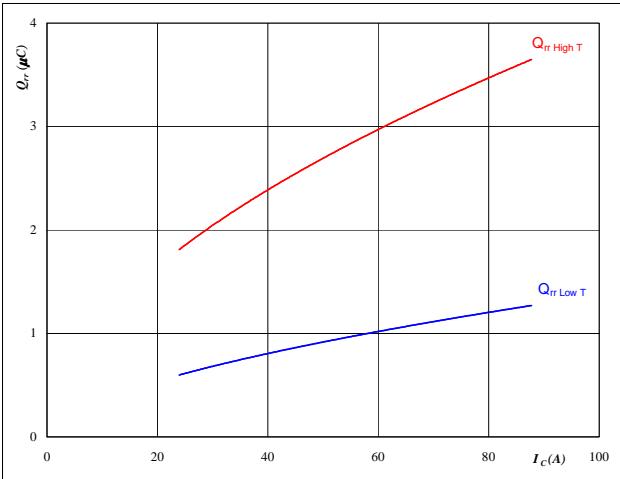
### Half Bridge IGBT and Neutral Point FWD

**Figure 13**

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$

FWD

**At**

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

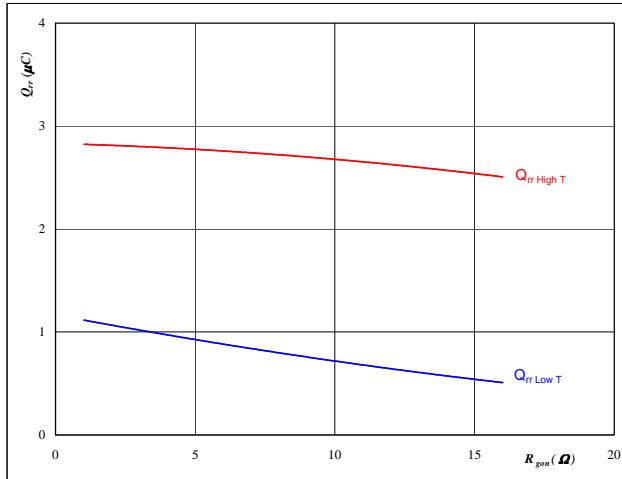
$$R_{gon} = 4 \quad \Omega$$

**Figure 14**

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

FWD

**At**

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_R = 350 \quad \text{V}$$

$$I_F = 56 \quad \text{A}$$

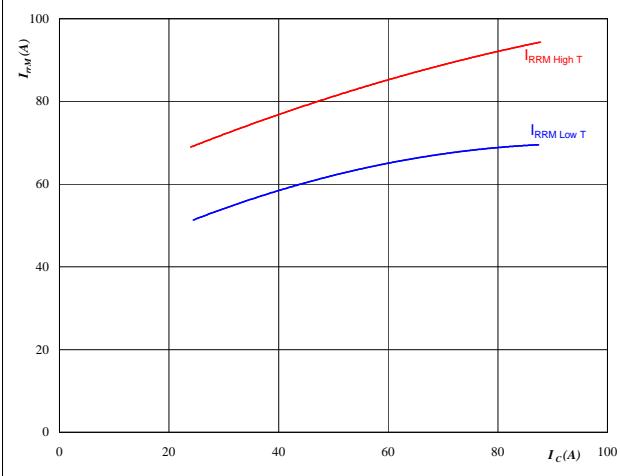
$$V_{GE} = \pm 15 \quad \text{V}$$

**Figure 15**

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$

FWD

**At**

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

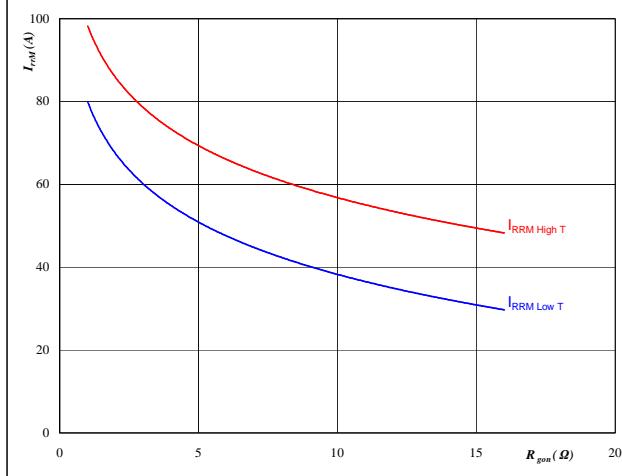
$$R_{gon} = 4 \quad \Omega$$

**Figure 16**

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

FWD

**At**

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_R = 350 \quad \text{V}$$

$$I_F = 56 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$



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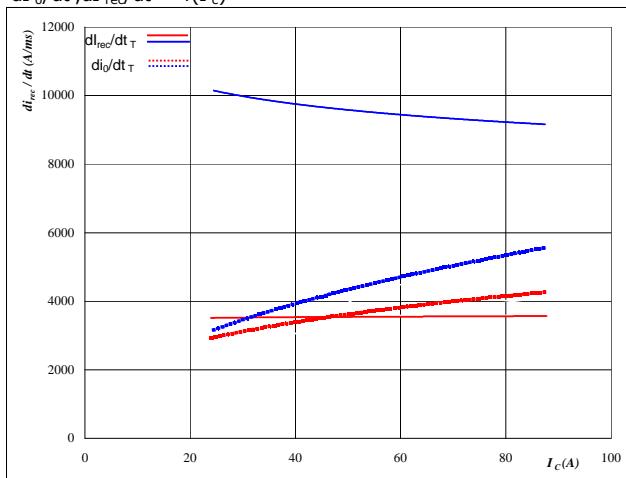
datasheet

## Half Bridge

### Half Bridge IGBT and Neutral Point FWD

**Figure 17**

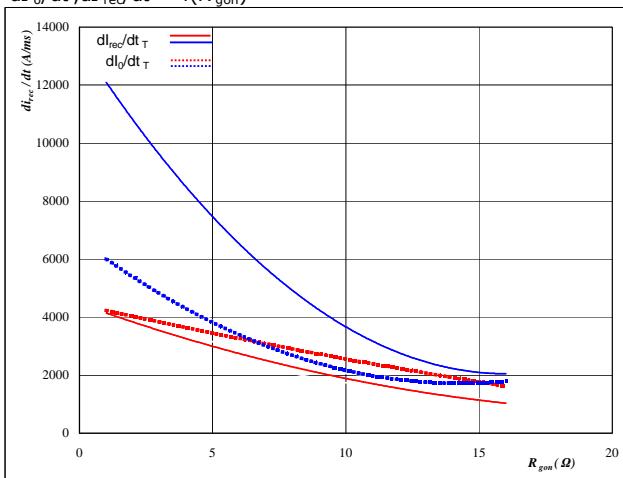
Typical rate of fall of forward  
and reverse recovery current as a  
function of collector current  
 $dI_{F0}/dt, dI_{Frec}/dt = f(I_c)$

**At**

T<sub>j</sub> = 25/125 °C  
V<sub>CE</sub> = 350 V  
V<sub>GE</sub> = ±15 V  
R<sub>gon</sub> = 4 Ω

**FWD****Figure 18**

Typical rate of fall of forward  
and reverse recovery current as a  
function of IGBT turn on gate resistor  
 $dI_{F0}/dt, dI_{Frec}/dt = f(R_{gon})$

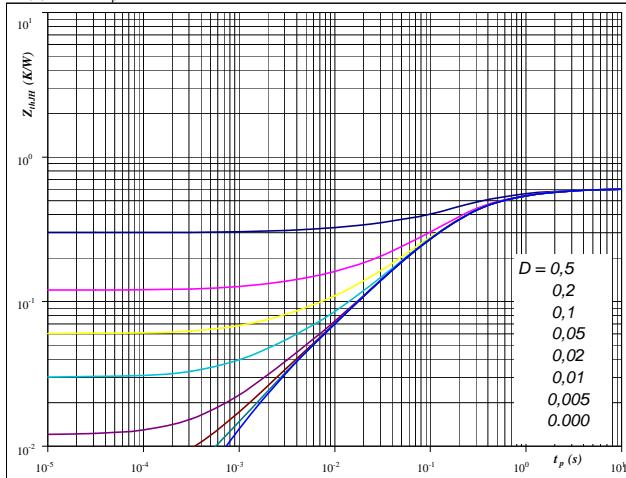
**At**

T<sub>j</sub> = 25/125 °C  
V<sub>R</sub> = 350 V  
I<sub>F</sub> = 56 A  
V<sub>GE</sub> = ±15 V

**Figure 19**

IGBT transient thermal impedance  
as a function of pulse width

$$Z_{thJH} = f(t_p)$$

**At**

D = t<sub>p</sub> / T  
R<sub>thJH</sub> = 0,60 K/W

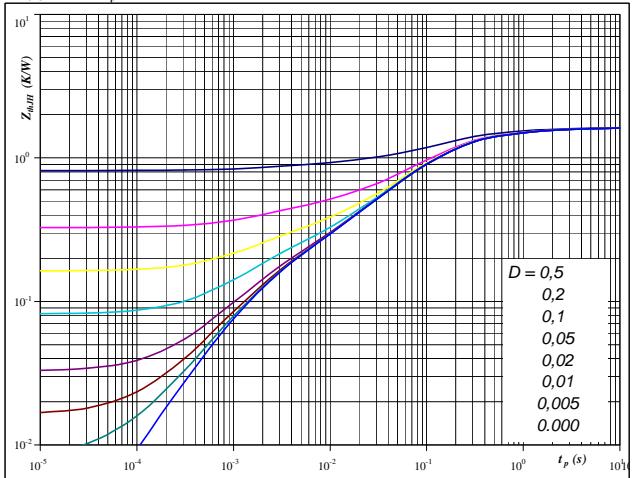
IGBT thermal model values

R (K/W)	Tau (s)
0,10	1,8E+00
0,23	2,9E-01
0,21	1,0E-01
0,05	1,4E-02
0,01	1,7E-03

**FWD****Figure 20**

FWD transient thermal impedance  
as a function of pulse width

$$Z_{thJH} = f(t_p)$$

**At**

D = t<sub>p</sub> / T  
R<sub>thJH</sub> = 1,63 K/W

FWD thermal model values

R (K/W)	Tau (s)
0,07	5,7E+00
0,17	1,2E+00
0,65	2,0E-01
0,51	6,6E-02
0,13	9,1E-03
0,11	1,5E-03

## Half Bridge

Half Bridge IGBT and Neutral Point FWD

**Figure 21**

IGBT

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

**At**

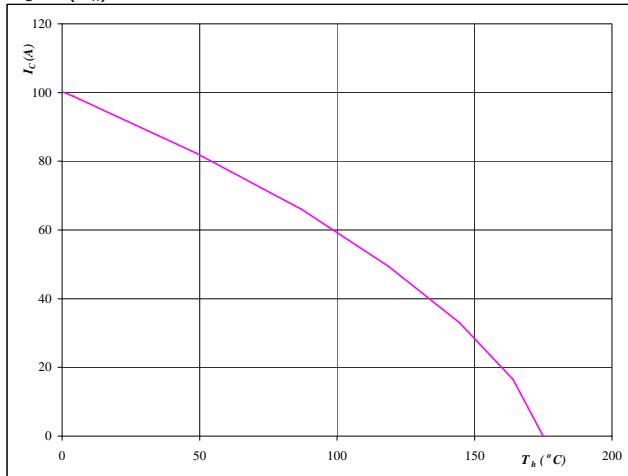
$$T_j = 175 \quad ^\circ\text{C}$$

**Figure 22**

IGBT

**Collector current as a function of heatsink temperature**

$$I_C = f(T_h)$$

**At**

$$T_j = 175 \quad ^\circ\text{C}$$

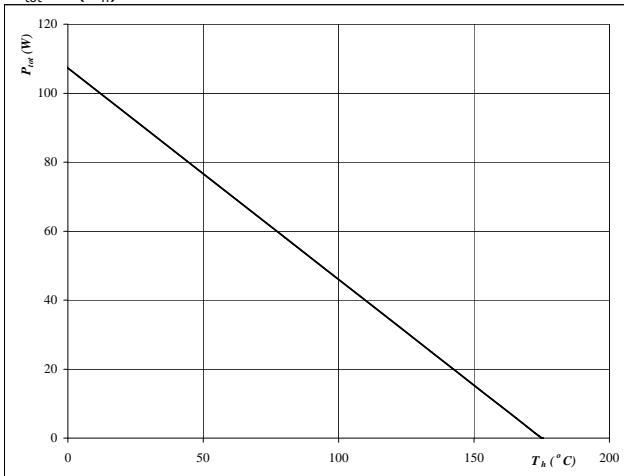
$$V_{GE} = 15 \quad \text{V}$$

**Figure 23**

FWD

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

**At**

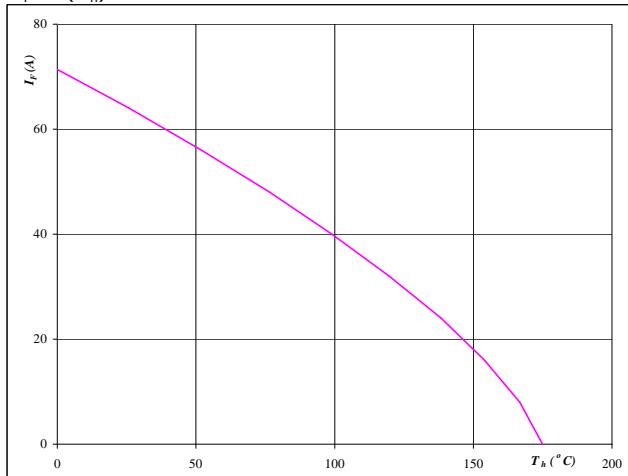
$$T_j = 175 \quad ^\circ\text{C}$$

**Figure 24**

FWD

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$

**At**

$$T_j = 175 \quad ^\circ\text{C}$$



Vincotech

**10-FZ12NMA080SH01-M260F  
10-PZ12NMA080SH01-M260FY**

datasheet

## Half Bridge

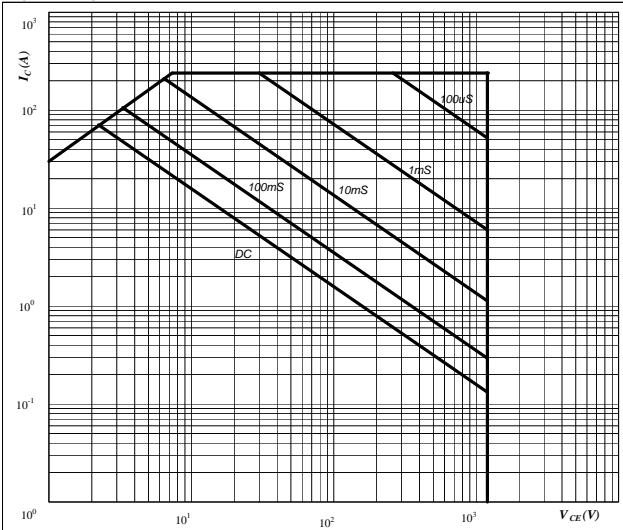
Half Bridge IGBT and Neutral Point FWD

**Figure 25**

IGBT

**Safe operating area as a function  
of collector-emitter voltage**

$$I_C = f(V_{CE})$$



**At**

$D =$  single pulse

$T_h =$  80 °C

$V_{GE} = \pm 15$  V

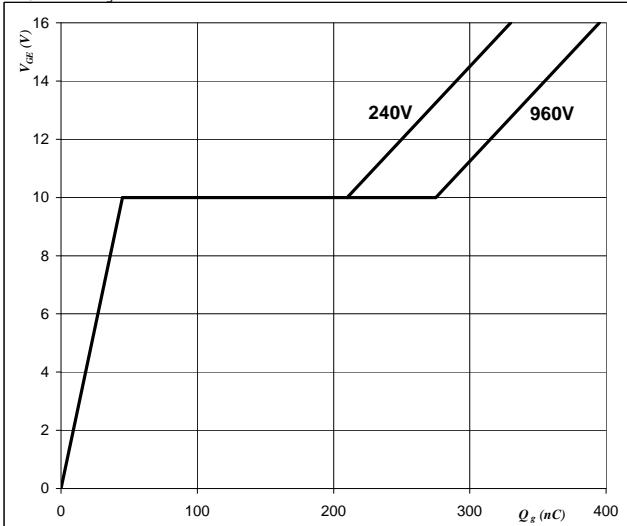
$T_j = T_{jmax}$  °C

**Figure 26**

IGBT

**Gate voltage vs Gate charge**

$$V_{GE} = f(Q_g)$$



**At**

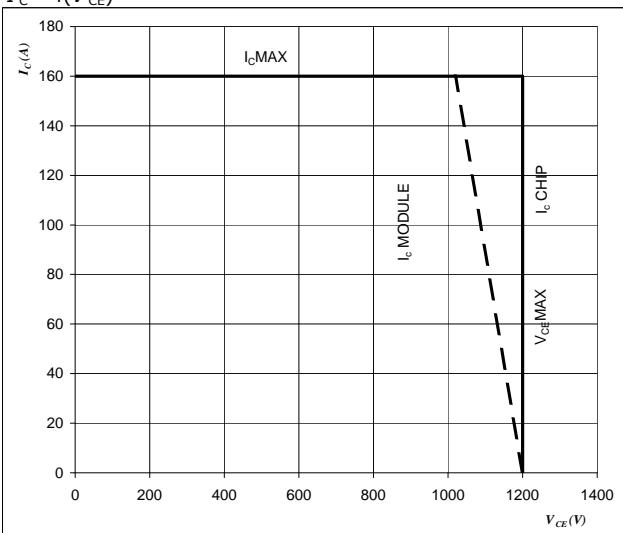
$$I_C = 80 \text{ A}$$

**Figure 27**

IGBT

**Reverse bias safe operating area**

$$I_C = f(V_{CE})$$



**At**

$T_j = T_{jmax}-25$  °C

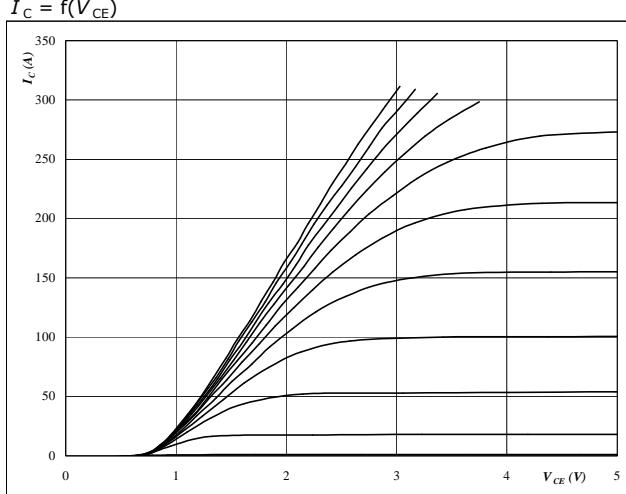
DC link <sub>minus</sub>=DC link plus

Switching mode : 3 level switching

## Neutral point

**Neutral Point IGBT and Half Bridge FWD**

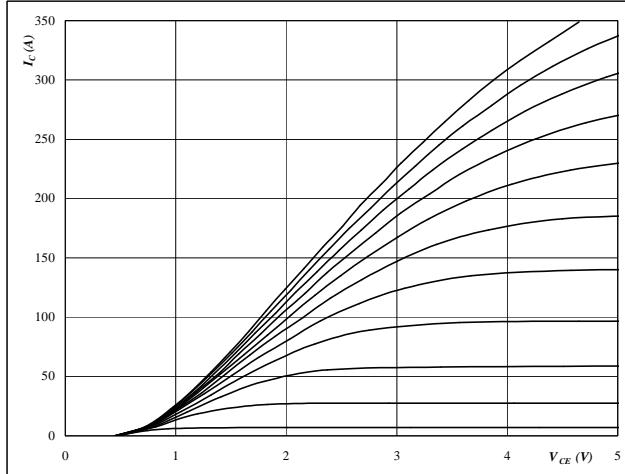
**Figure 1**  
**Typical output characteristics**  
 $I_C = f(V_{CE})$



**At**  
 $t_p = 250 \mu\text{s}$   
 $T_j = 25^\circ\text{C}$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

IGBT

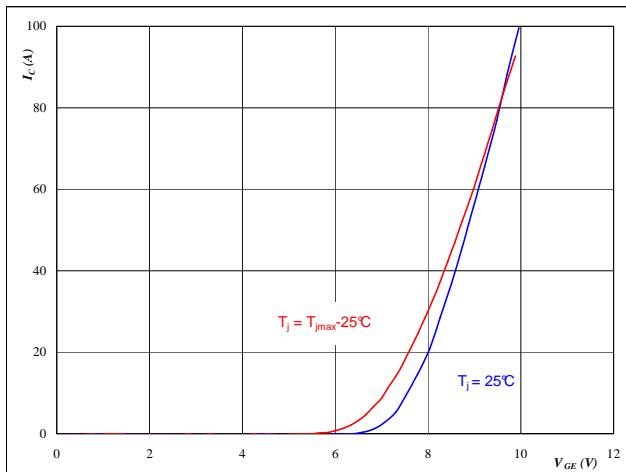
**Figure 2**  
**Typical output characteristics**  
 $I_C = f(V_{CE})$



**At**  
 $t_p = 250 \mu\text{s}$   
 $T_j = 125^\circ\text{C}$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

IGBT

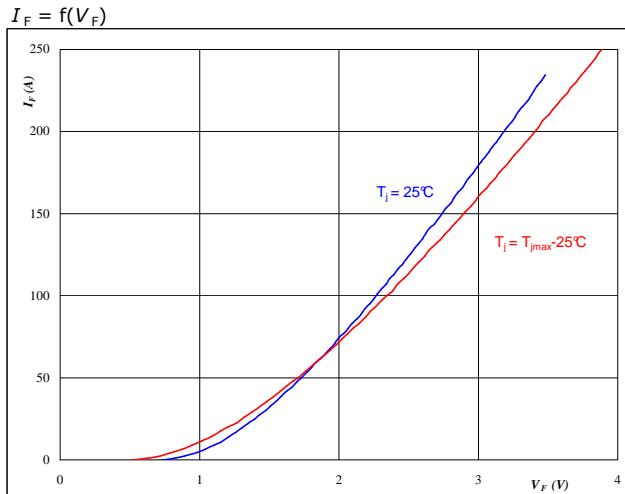
**Figure 3**  
**Typical transfer characteristics**  
 $I_C = f(V_{GE})$



**At**  
 $t_p = 250 \mu\text{s}$   
 $V_{CE} = 10 \text{ V}$

IGBT

**Figure 4**  
**Typical diode forward current as a function of forward voltage**  
 $I_F = f(V_F)$



**At**  
 $t_p = 250 \mu\text{s}$

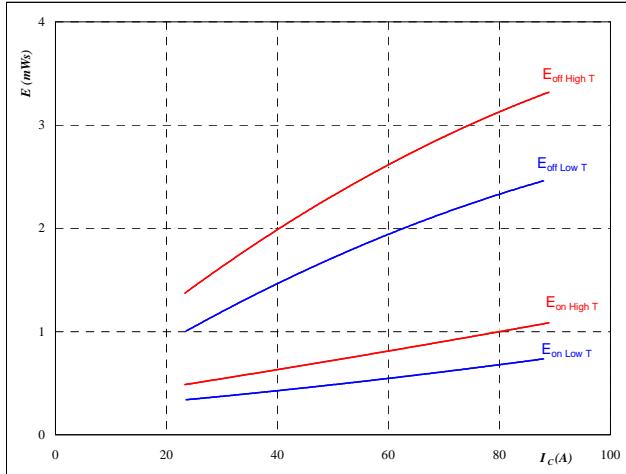
FWD

## Neutral point

**Neutral Point IGBT and Half Bridge FWD**

**Figure 5**  
**Typical switching energy losses  
as a function of collector current**

$$E = f(I_C)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

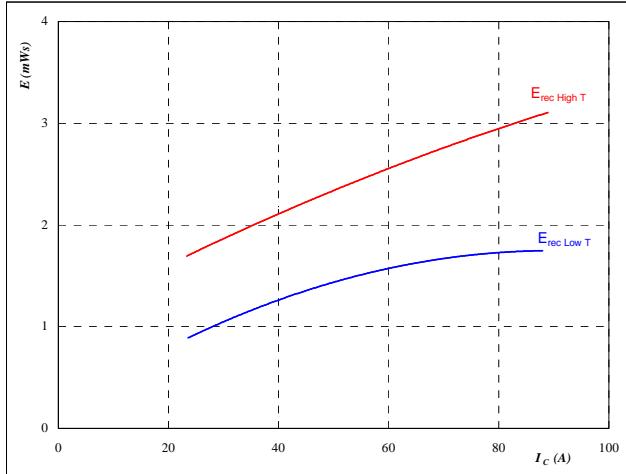
$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

$$R_{goff} = 4 \quad \Omega$$

**Figure 7**  
**Typical reverse recovery energy loss  
as a function of collector current**

$$E_{rec} = f(I_C)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

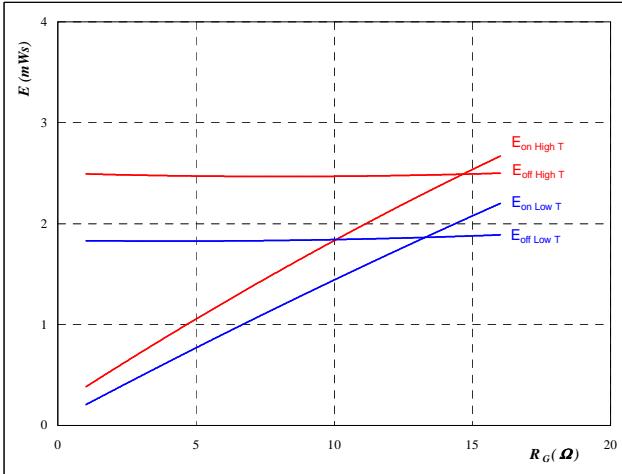
$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

**Figure 6**  
**Typical switching energy losses  
as a function of gate resistor**

$$E = f(R_G)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

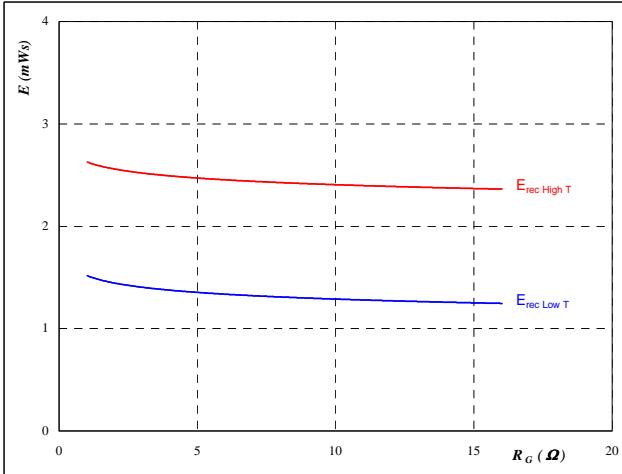
$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 56 \quad \text{A}$$

**Figure 8**  
**Typical reverse recovery energy loss  
as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$I_C = 56 \quad \text{A}$$



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10-PZ12NMA080SH01-M260FY

datasheet

## Neutral point

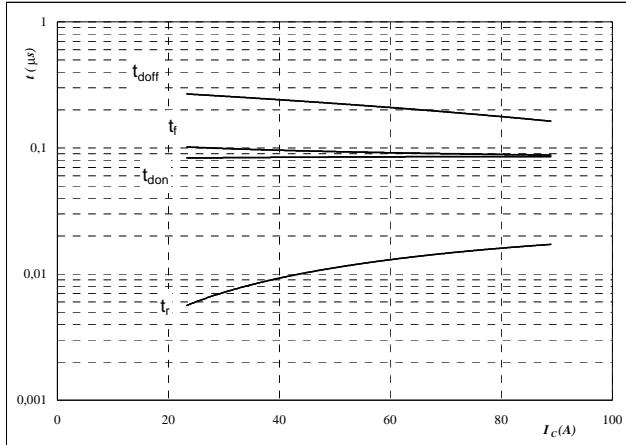
Neutral Point IGBT and Half Bridge FWD

Figure 9

IGBT

Typical switching times as a function of collector current

$$t = f(I_C)$$



With an inductive load at

$$T_j = 125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

$$R_{gon} = 4 \quad \Omega$$

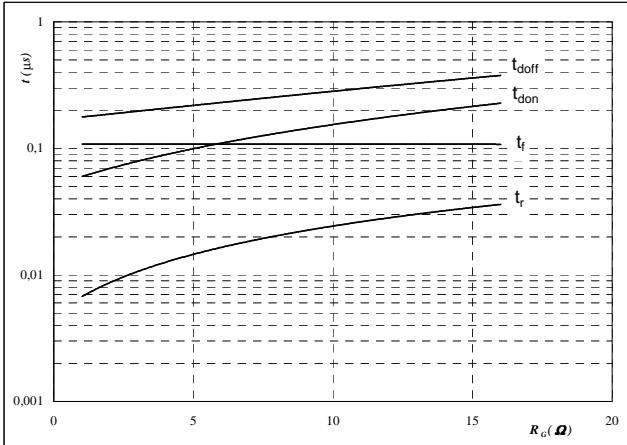
$$R_{goff} = 4 \quad \Omega$$

Figure 10

IGBT

Typical switching times as a function of gate resistor

$$t = f(R_G)$$



With an inductive load at

$$T_j = 125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

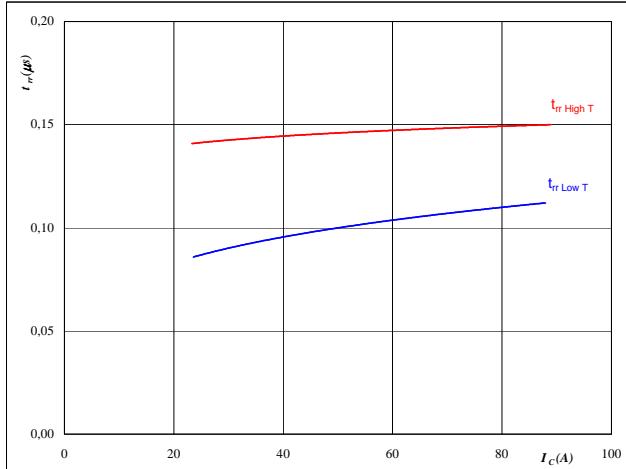
$$I_C = 56 \quad \text{A}$$

Figure 11

FWD

Typical reverse recovery time as a function of collector current

$$t_{rr} = f(I_C)$$



At

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

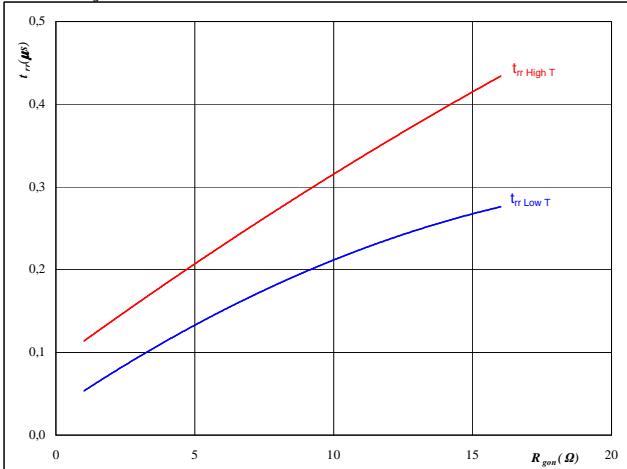
$$R_{gon} = 4 \quad \Omega$$

Figure 12

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$$t_{rr} = f(R_{gon})$$



At

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_R = 350 \quad \text{V}$$

$$I_F = 56 \quad \text{A}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

## Neutral point

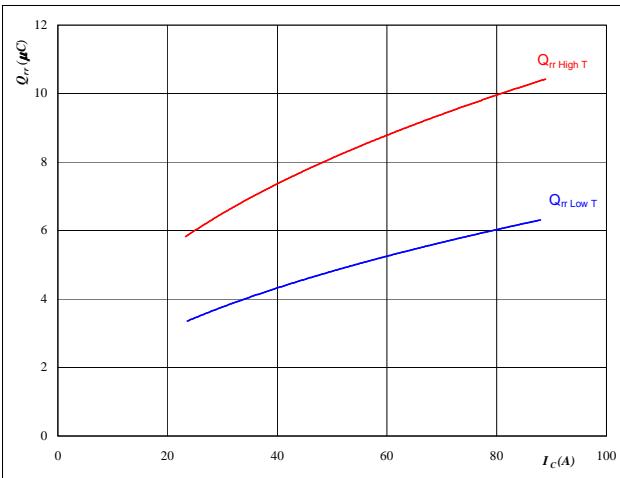
Neutral Point IGBT and Half Bridge FWD

**Figure 13**

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_c)$$

FWD

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

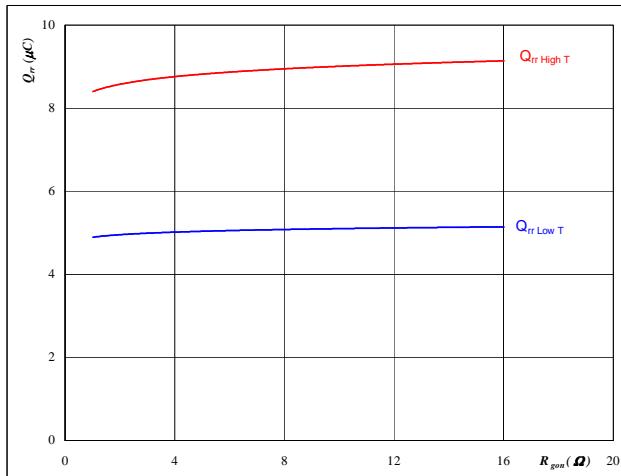
$$R_{gon} = 4 \text{ } \Omega$$

**Figure 14**

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$

FWD

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

$$V_R = 350 \text{ V}$$

$$I_F = 56 \text{ A}$$

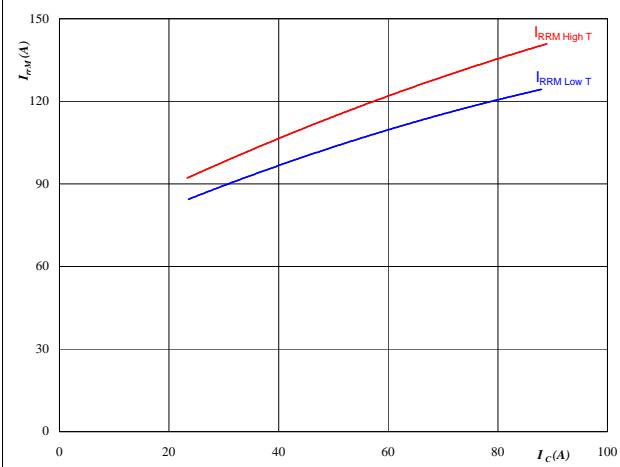
$$V_{GE} = \pm 15 \text{ V}$$

**Figure 15**

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_c)$$

FWD

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

$$V_{CE} = 350 \text{ V}$$

$$V_{GE} = \pm 15 \text{ V}$$

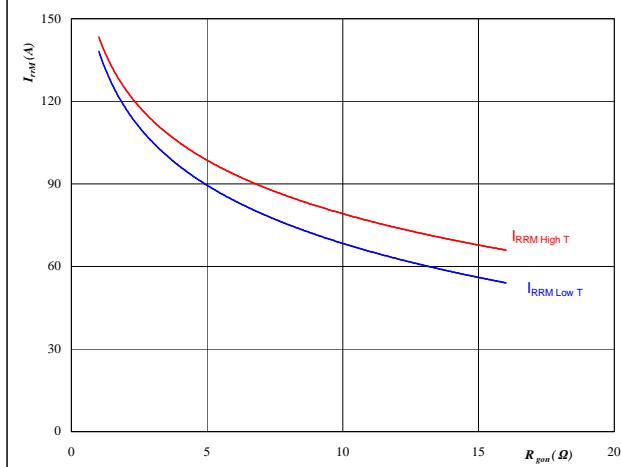
$$R_{gon} = 4 \text{ } \Omega$$

**Figure 16**

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$

FWD

**At**

$$T_j = 25/125 \text{ } ^\circ\text{C}$$

$$V_R = 350 \text{ V}$$

$$I_F = 56 \text{ A}$$

$$V_{GE} = \pm 15 \text{ V}$$



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10-PZ12NMA080SH01-M260FY**

datasheet

## Neutral point

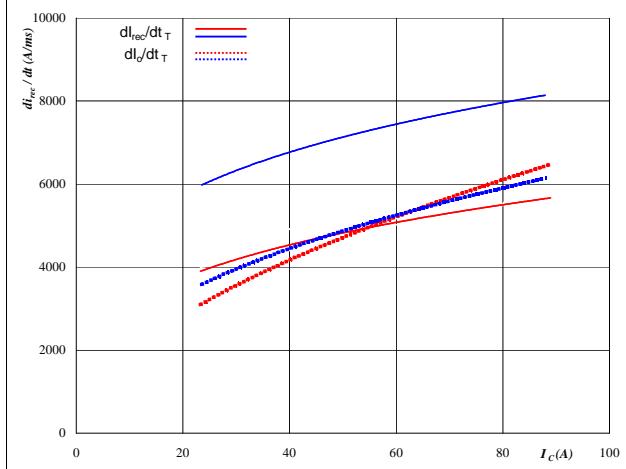
Neutral Point IGBT and Half Bridge FWD

**Figure 17**

FWD

**Typical rate of fall of forward and reverse recovery current as a function of collector current**

$$dI_0/dt, dI_{rec}/dt = f(I_c)$$

**At**

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_{CE} = 350 \quad \text{V}$$

$$V_{GE} = \pm 15 \quad \text{V}$$

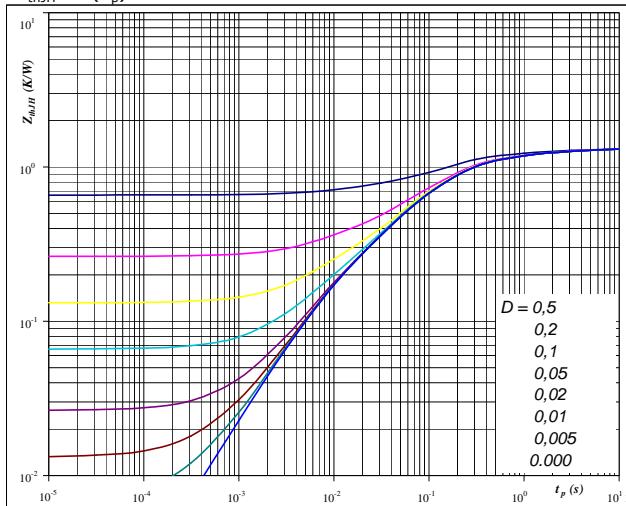
$$R_{gon} = 4 \quad \Omega$$

**Figure 19**

IGBT

**IGBT transient thermal impedance as a function of pulse width**

$$Z_{thJH} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{thJH} = 1,32 \quad \text{K/W}$$

IGBT thermal model values

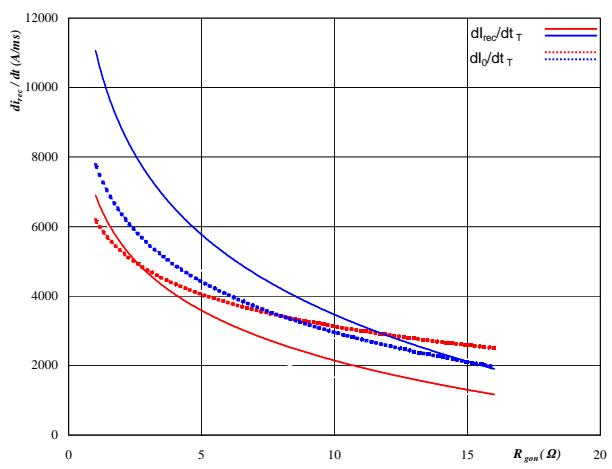
R (K/W)	Tau (s)
0,06	6,4E+00
0,17	1,3E+00
0,35	2,5E-01
0,60	8,5E-02
0,13	8,9E-03

**Figure 18**

FWD

**Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor**

$$dI_0/dt, dI_{rec}/dt = f(R_{gon})$$

**At**

$$T_j = 25/125 \quad ^\circ\text{C}$$

$$V_R = 350 \quad \text{V}$$

$$I_F = 56 \quad \text{A}$$

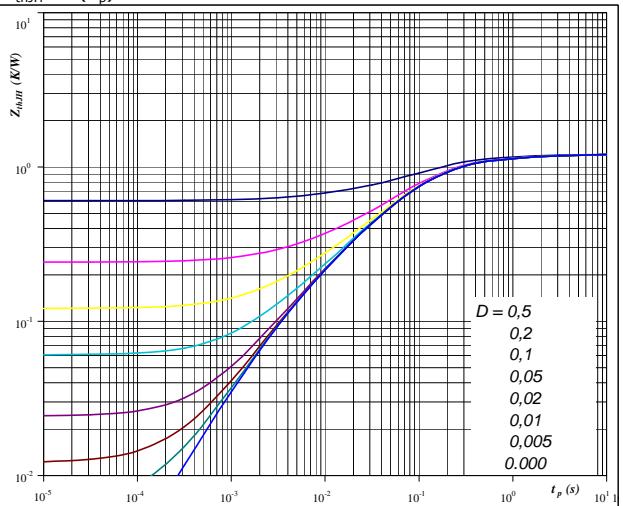
$$V_{GE} = \pm 15 \quad \text{V}$$

**Figure 19**

FWD

**FWD transient thermal impedance as a function of pulse width**

$$Z_{thJH} = f(t_p)$$

**At**

$$D = t_p / T$$

$$R_{thJH} = 1,21 \quad \text{K/W}$$

FWD thermal model values

R (K/W)	Tau (s)
0,03	6,2E+00
0,11	1,1E+00
0,34	2,0E-01
0,54	6,8E-02
0,14	1,2E-02
0,05	2,8E-03

## Neutral point

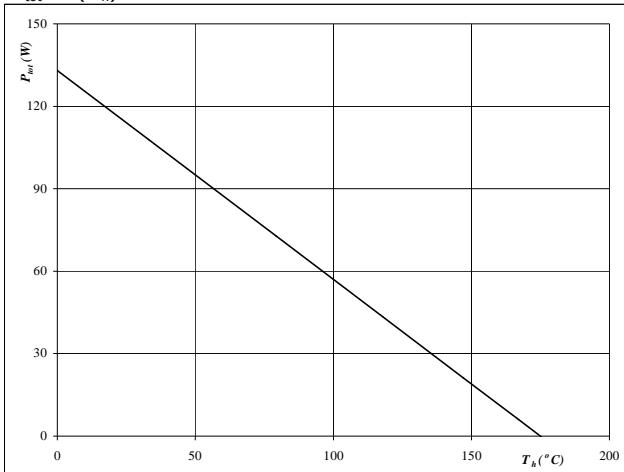
Neutral Point IGBT and Half Bridge FWD

**Figure 21**

IGBT

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

**At**

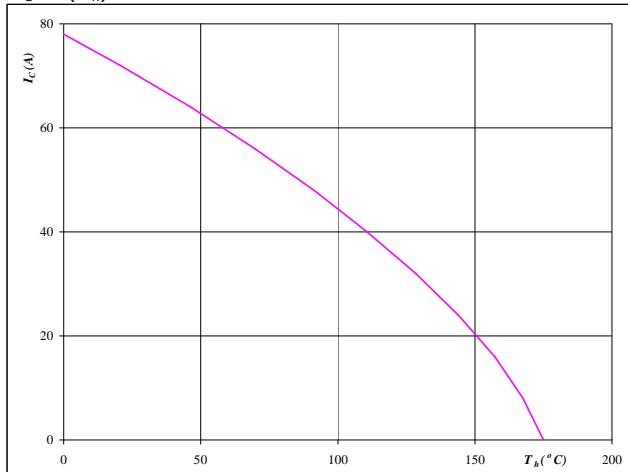
$$T_j = 175 \quad ^\circ\text{C}$$

**Figure 22**

IGBT

**Collector current as a function of heatsink temperature**

$$I_C = f(T_h)$$

**At**

$$T_j = 175 \quad ^\circ\text{C}$$

$$V_{GE} = 15 \quad \text{V}$$

**Figure 23**

FWD

**Power dissipation as a function of heatsink temperature**

$$P_{\text{tot}} = f(T_h)$$

**At**

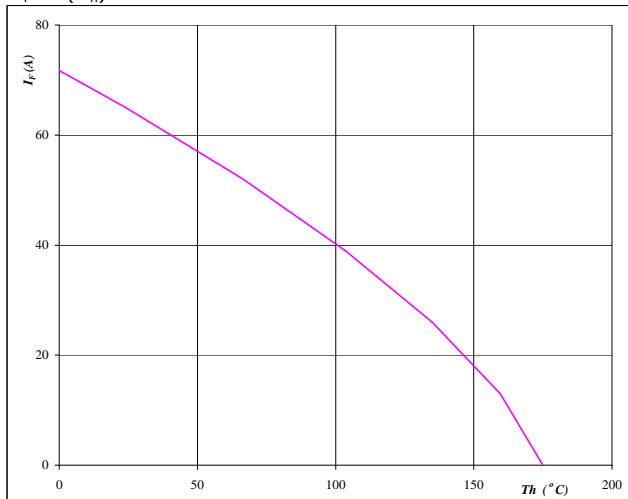
$$T_j = 175 \quad ^\circ\text{C}$$

**Figure 24**

FWD

**Forward current as a function of heatsink temperature**

$$I_F = f(T_h)$$

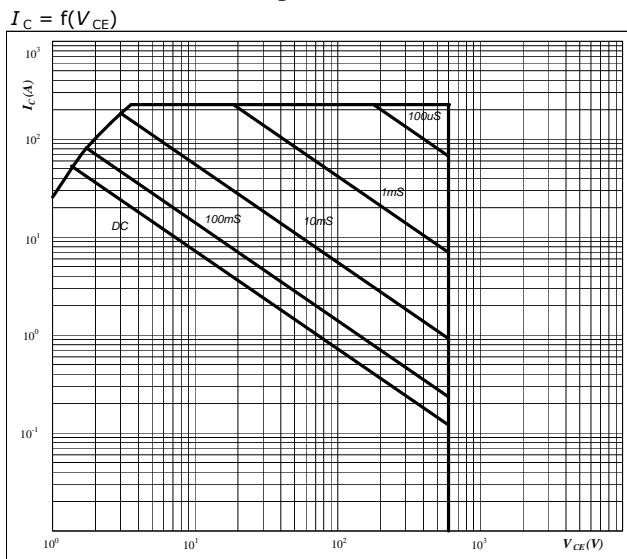
**At**

$$T_j = 175 \quad ^\circ\text{C}$$

## Neutral point

**Neutral Point IGBT and Half Bridge FWD**

**Figure 25**  
**Safe operating area as a function  
of collector-emitter voltage**



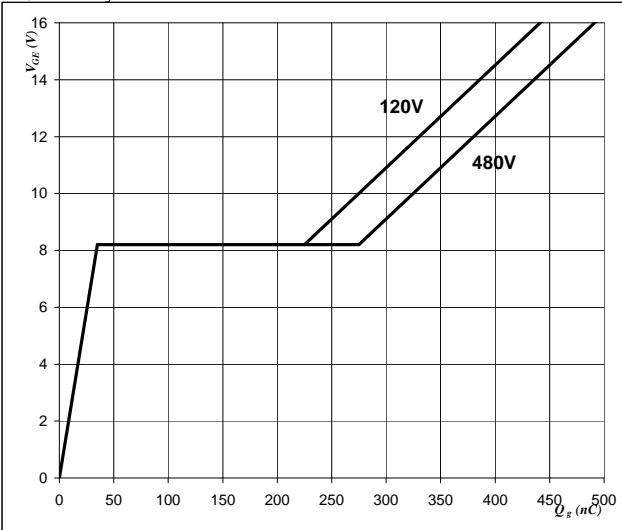
**At**

$D$  = single pulse  
 $T_h$  = 80 °C  
 $V_{GE}$  = 15 V  
 $T_j$  =  $T_{jmax}$  °C

**Figure 26**  
**IGBT**

**Gate voltage vs Gate charge**

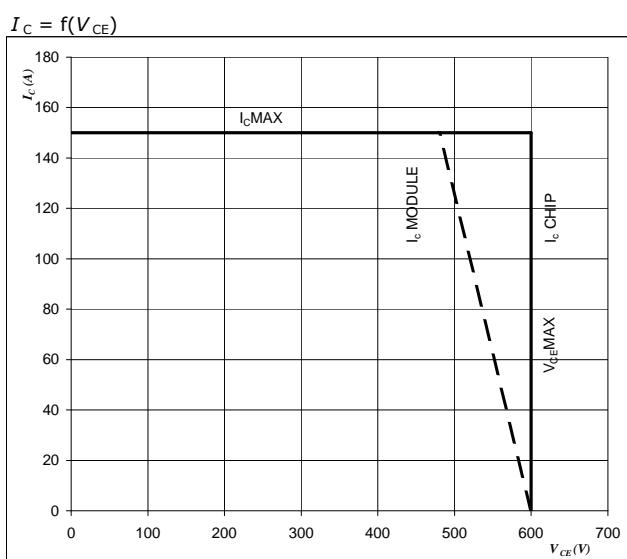
$$V_{GE} = f(Q_g)$$



**At**

$I_C$  = 75 A

**Figure 27**  
**Reverse bias safe operating area**



**At**

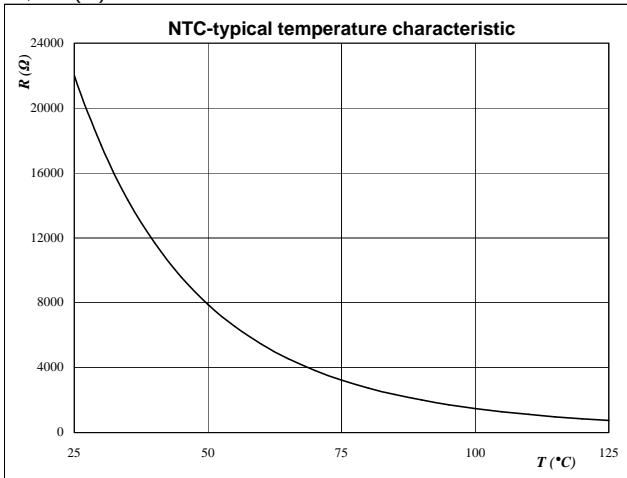
$T_j$  =  $T_{jmax}-25$  °C  
DC link<sub>minus</sub>=DC link<sub>plus</sub>  
Switching mode : 3 level switching

## Thermistor

**Figure 1** Thermistor

**Typical NTC characteristic  
as a function of temperature**

$$R_T = f(T)$$

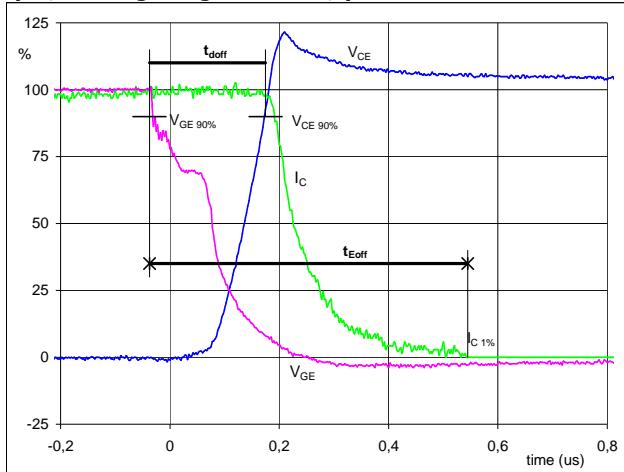


## Switching Definitions Neutral point IGBT

**General conditions**

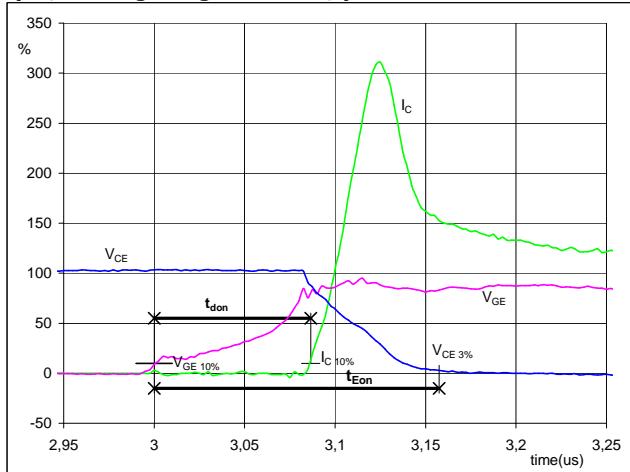
$T_j$	= 125 °C
$R_{gon}$	= 4 Ω
$R_{goff}$	= 4 Ω

**Figure 1** Neutral point IGBT  
**Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$**   
 $(t_{Eoff} = \text{integrating time for } E_{off})$



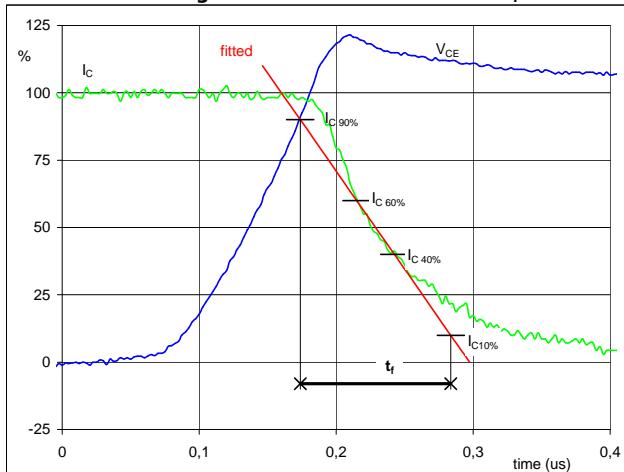
$V_{GE\ (0\%)} = -15$  V  
 $V_{GE\ (100\%)} = 15$  V  
 $V_C\ (100\%) = 350$  V  
 $I_C\ (100\%) = 56$  A  
 $t_{doff} = 0,21$  μs  
 $t_{Eoff} = 0,58$  μs

**Figure 2** Neutral point IGBT  
**Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$**   
 $(t_{Eon} = \text{integrating time for } E_{on})$



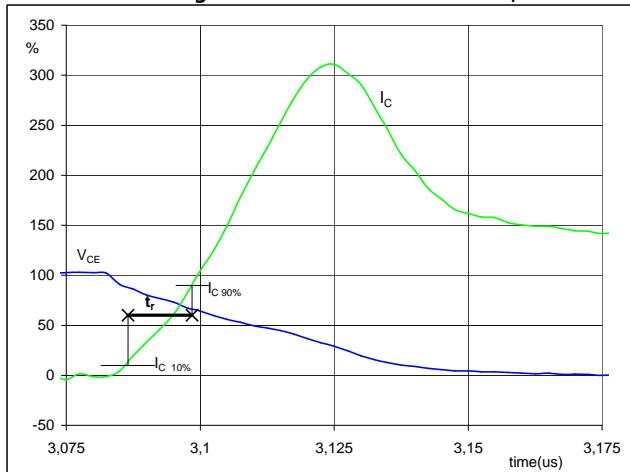
$V_{GE\ (0\%)} = -15$  V  
 $V_{GE\ (100\%)} = 15$  V  
 $V_C\ (100\%) = 350$  V  
 $I_C\ (100\%) = 56$  A  
 $t_{don} = 0,09$  μs  
 $t_{Eon} = 0,16$  μs

**Figure 3** Neutral point IGBT  
**Turn-off Switching Waveforms & definition of  $t_f$**



$V_C\ (100\%) = 350$  V  
 $I_C\ (100\%) = 56$  A  
 $t_f = 0,11$  μs

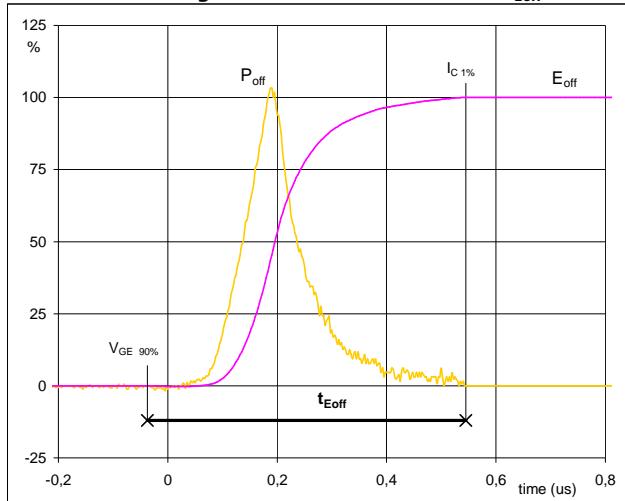
**Figure 4** Neutral point IGBT  
**Turn-on Switching Waveforms & definition of  $t_r$**



$V_C\ (100\%) = 350$  V  
 $I_C\ (100\%) = 56$  A  
 $t_r = 0,01$  μs

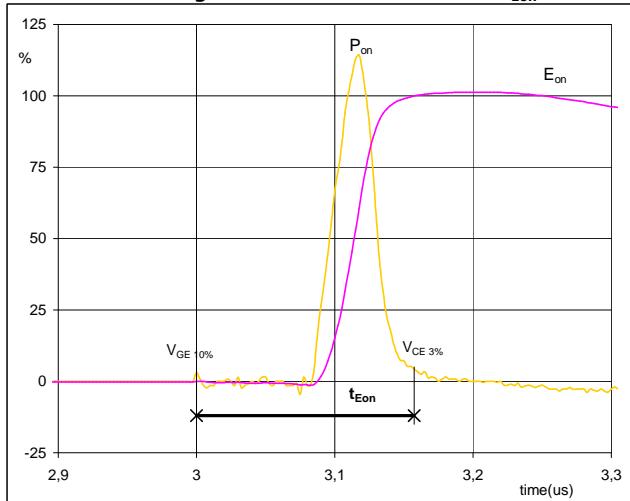
## Switching Definitions Neutral point IGBT

**Figure 5** Neutral point IGBT  
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



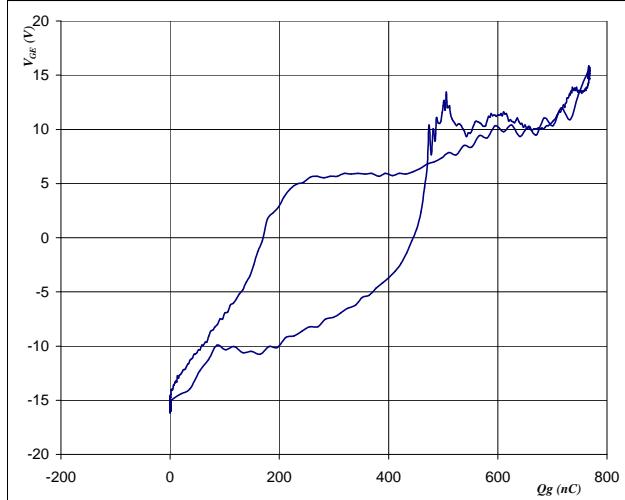
$P_{off}$  (100%) = 19,56 kW  
 $E_{off}$  (100%) = 2,50 mJ  
 $t_{Eoff}$  = 0,58  $\mu$ s

**Figure 6** Neutral point IGBT  
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



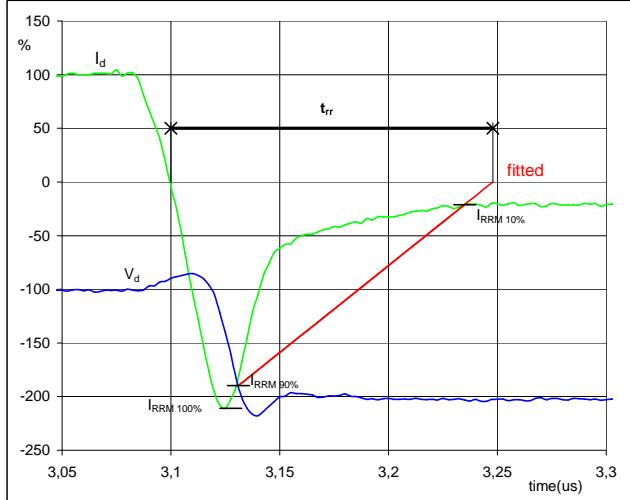
$P_{on}$  (100%) = 19,56 kW  
 $E_{on}$  (100%) = 0,75 mJ  
 $t_{Eon}$  = 0,16  $\mu$ s

**Figure 7** Neutral point IGBT  
**Gate voltage vs Gate charge (measured)**



$V_{GE\ off}$  = -15 V  
 $V_{GE\ on}$  = 15 V  
 $V_C$  (100%) = 350 V  
 $I_C$  (100%) = 56 A  
 $Q_g$  = 775,97 nC

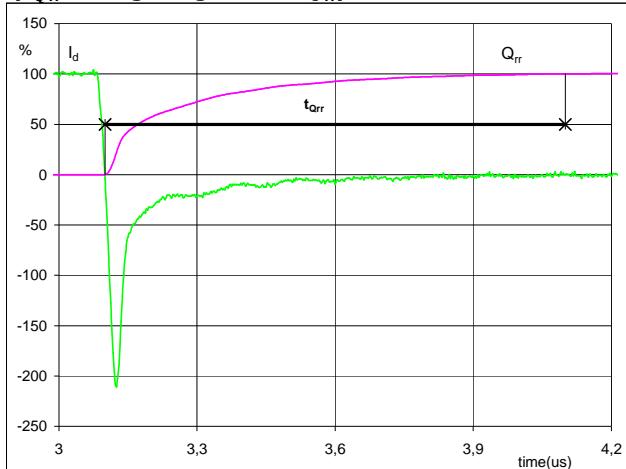
**Figure 8** Neutral point FWD  
**Turn-off Switching Waveforms & definition of  $t_{rr}$**



$V_d$  (100%) = 350 V  
 $I_d$  (100%) = 56 A  
 $I_{RRM}$  (100%) = -118 A  
 $t_{rr}$  = 0,15  $\mu$ s

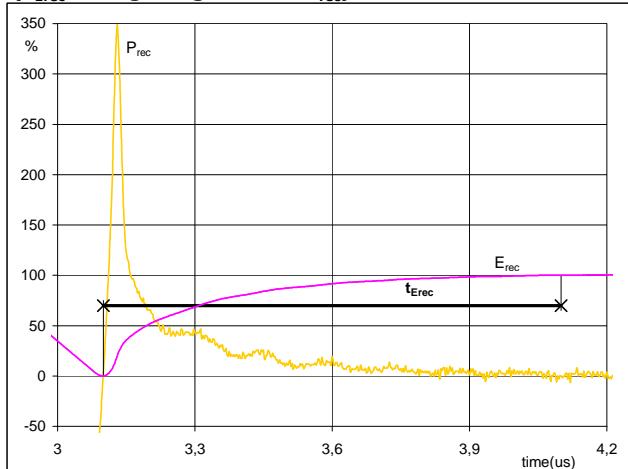
## Switching Definitions Neutral point IGBT

**Figure 9** Neutral point IGBT  
**Turn-on Switching Waveforms & definition of  $t_{Q_{rr}}$**   
 $(t_{Q_{rr}} = \text{integrating time for } Q_{rr})$



$I_d$  (100%) = 56 A  
 $Q_{rr}$  (100%) = 8,22  $\mu\text{C}$   
 $t_{Q_{rr}} = 1,00 \mu\text{s}$

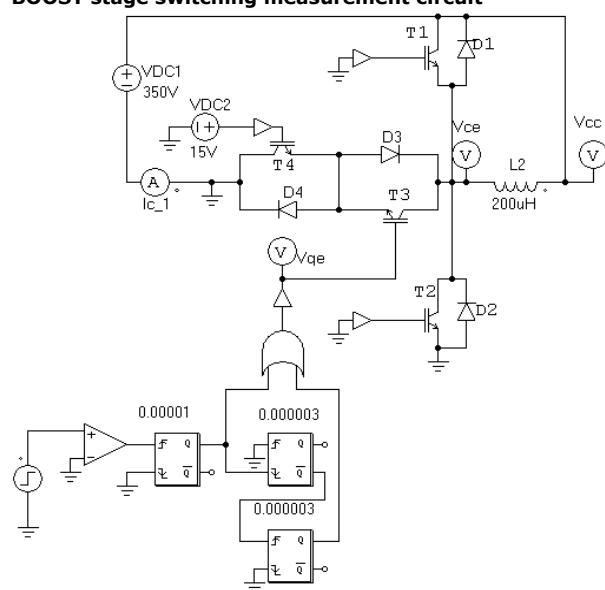
**Figure 10** Neutral point IGBT  
**Turn-on Switching Waveforms & definition of  $t_{E_{rec}}$**   
 $(t_{E_{rec}} = \text{integrating time for } E_{rec})$



$P_{rec}$  (100%) = 19,56 kW  
 $E_{rec}$  (100%) = 2,42 mJ  
 $t_{E_{rec}} = 1,00 \mu\text{s}$

## Measurement circuits

**Figure 11**  
**BOOST stage switching measurement circuit**

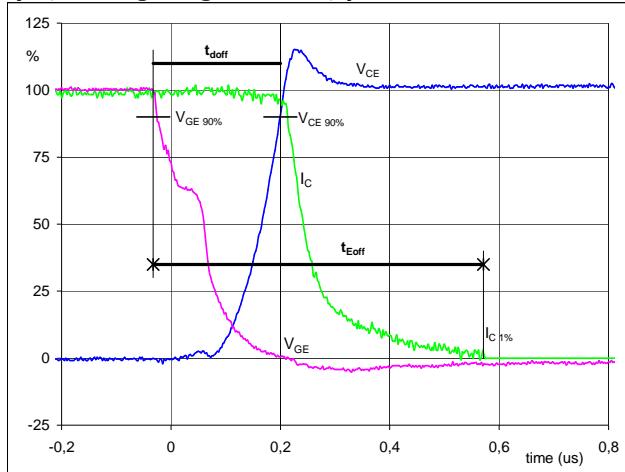


## Switching Definitions Half Bridge IGBT

**General conditions**

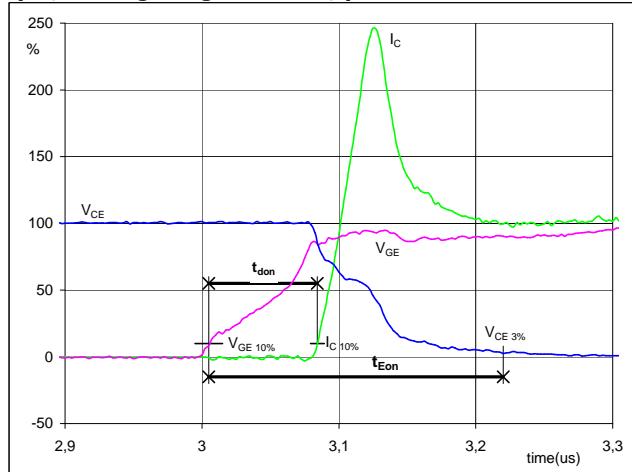
$T_j$	= 125 °C
$R_{gon}$	= 4 Ω
$R_{goff}$	= 4 Ω

**Figure 1** Half Bridge IGBT  
**Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$**   
 $(t_{Eoff} = \text{integrating time for } E_{off})$



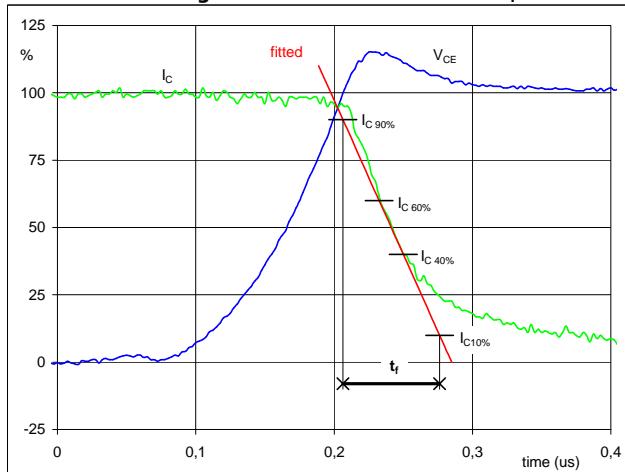
$V_{GE\ (0\%)} = -15$  V  
 $V_{GE\ (100\%)} = 15$  V  
 $V_C\ (100\%) = 700$  V  
 $I_C\ (100\%) = 56$  A  
 $t_{doff} = 0,23$  μs  
 $t_{Eoff} = 0,60$  μs

**Figure 2** Half Bridge IGBT  
**Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$**   
 $(t_{Eon} = \text{integrating time for } E_{on})$



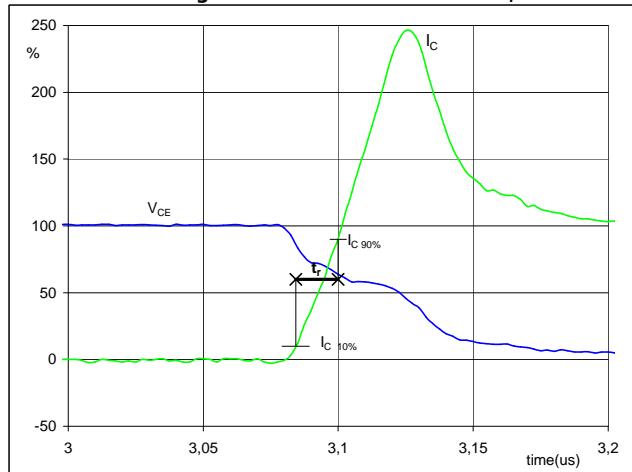
$V_{GE\ (0\%)} = -15$  V  
 $V_{GE\ (100\%)} = 15$  V  
 $V_C\ (100\%) = 700$  V  
 $I_C\ (100\%) = 56$  A  
 $t_{don} = 0,08$  μs  
 $t_{Eon} = 0,21$  μs

**Figure 3** Half Bridge IGBT  
**Turn-off Switching Waveforms & definition of  $t_f$**



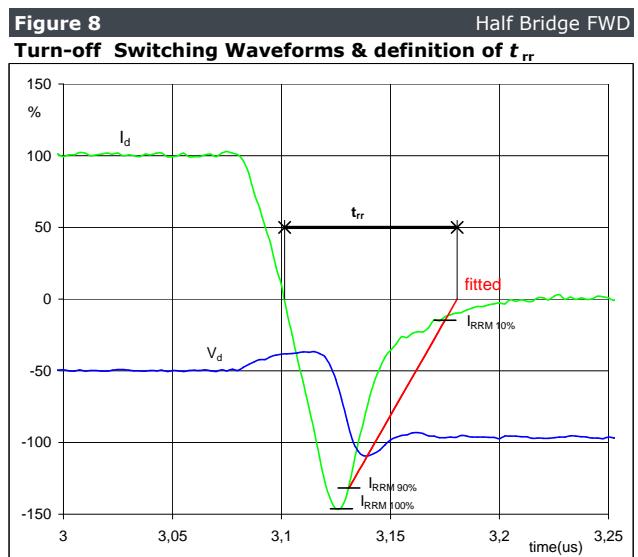
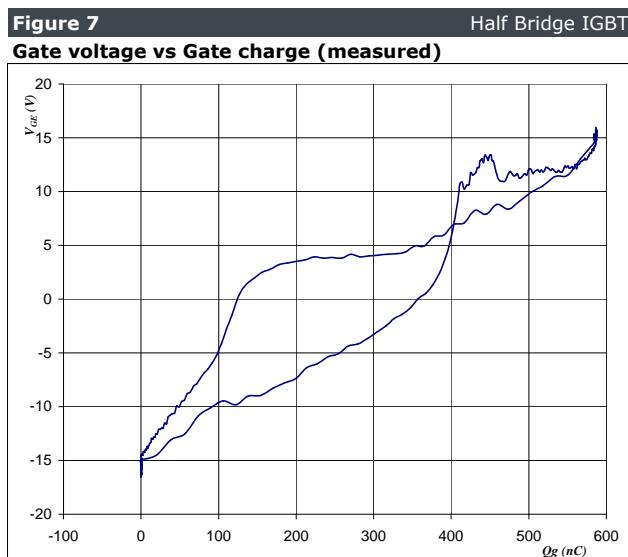
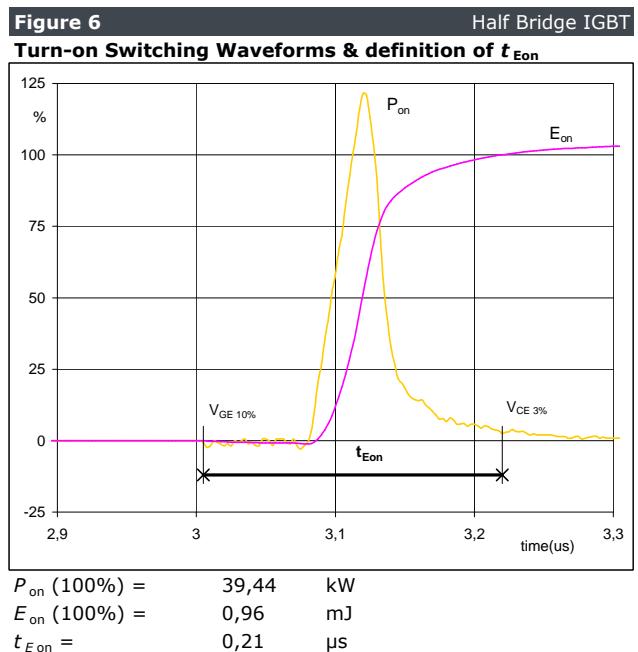
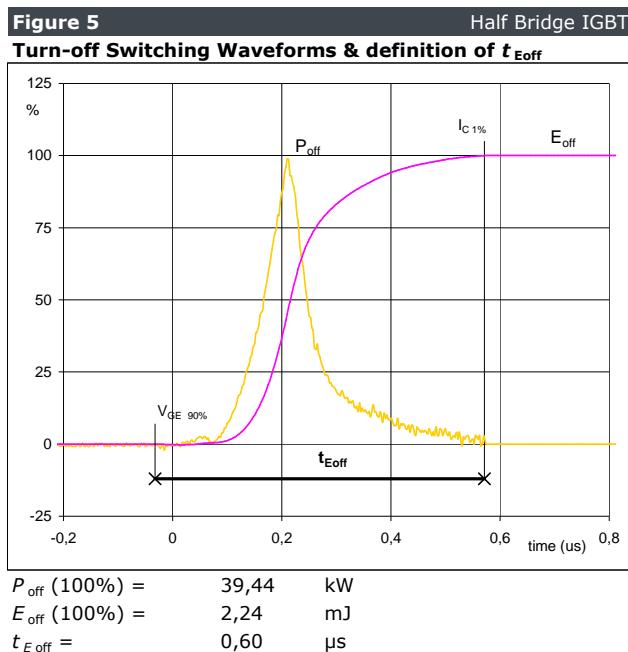
$V_C\ (100\%) = 700$  V  
 $I_C\ (100\%) = 56$  A  
 $t_f = 0,07$  μs

**Figure 4** Half Bridge IGBT  
**Turn-on Switching Waveforms & definition of  $t_r$**

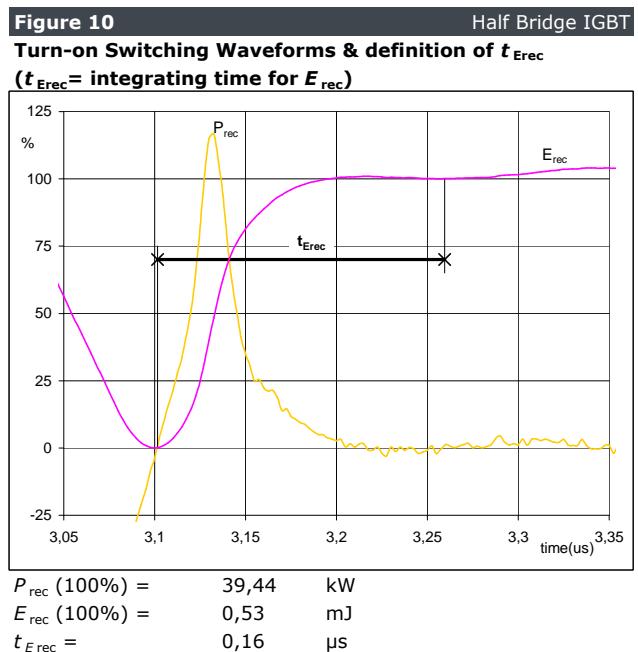
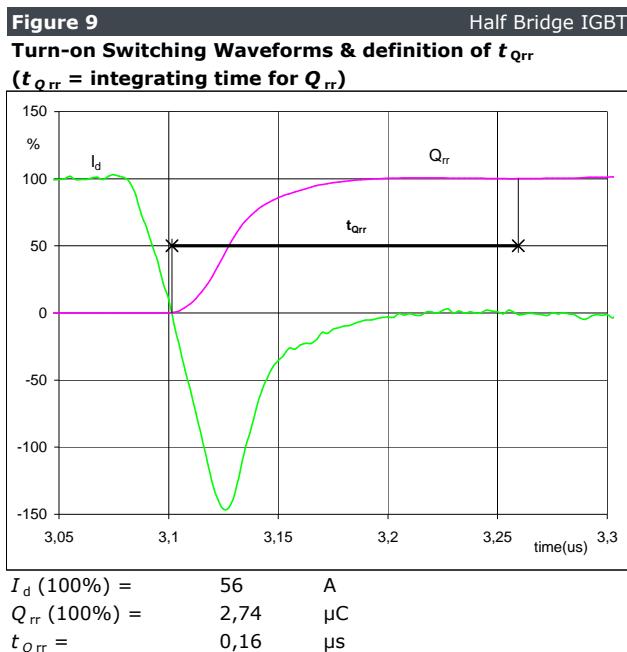


$V_C\ (100\%) = 700$  V  
 $I_C\ (100\%) = 56$  A  
 $t_r = 0,02$  μs

## Switching Definitions Half Bridge IGBT

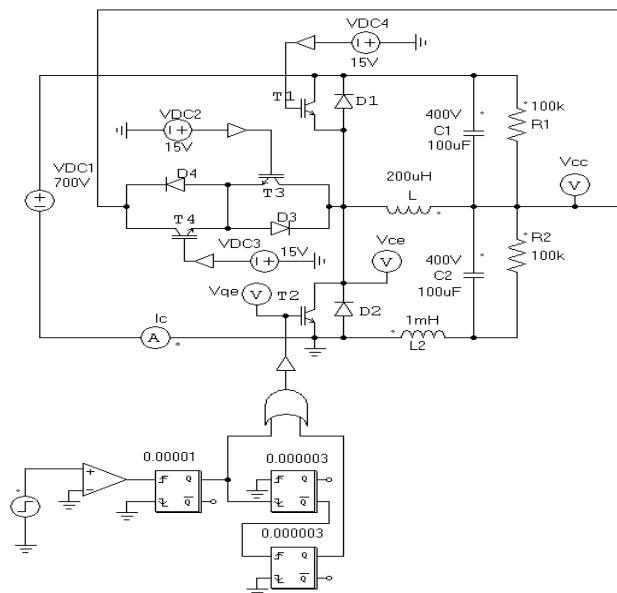


## Switching Definitions Half Bridge IGBT



## Measurement circuits

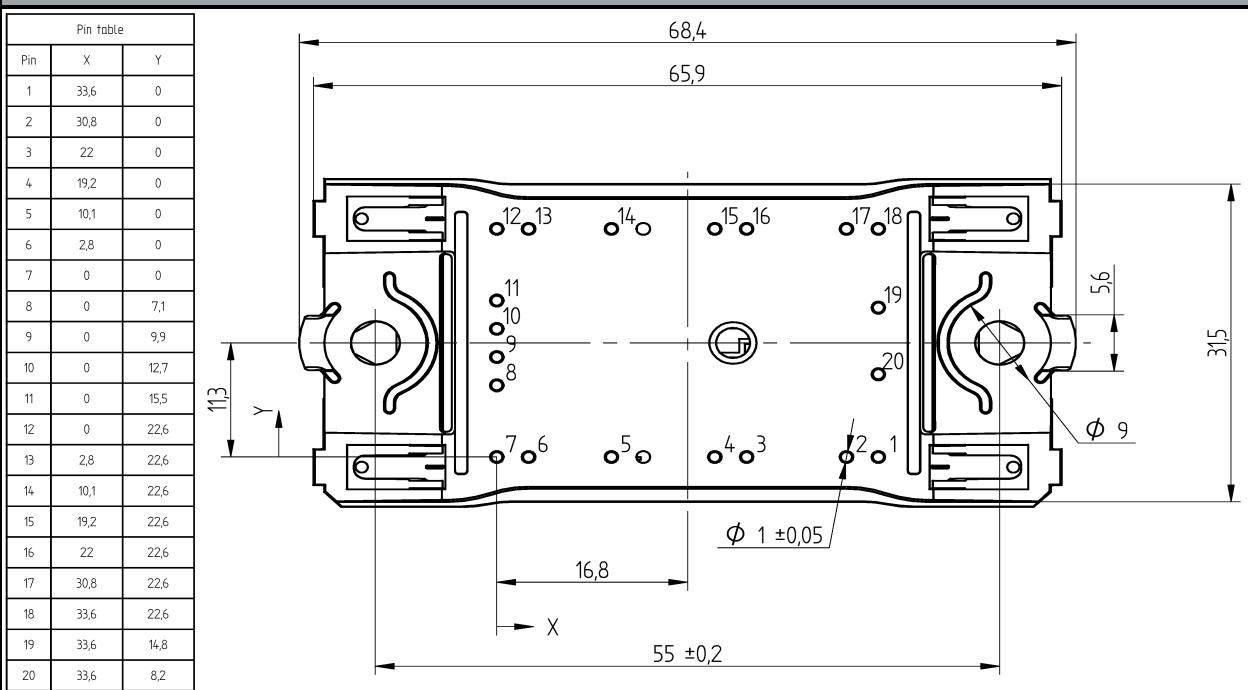
**Figure 11**  
**BUCK stage switching measurement circuit**



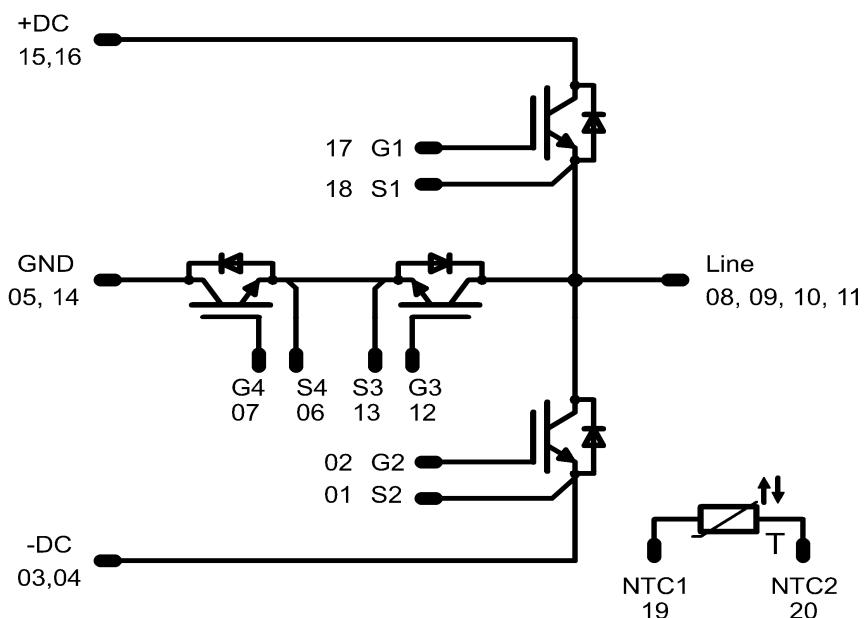
## **Ordering Code and Marking - Outline - Pinout**

<b>Version</b>	<b>Ordering Code</b>	<b>in DataMatrix as</b>	<b>in packaging barcode as</b>
without thermal paste 12mm housing	10-FZ12NMA080SH01-M260F	M260F	M260F
without thermal paste 12mm housing	10-PZ12NMA080SH01-M260FY	M260FY	M260FY

## Outline



## Pinout



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